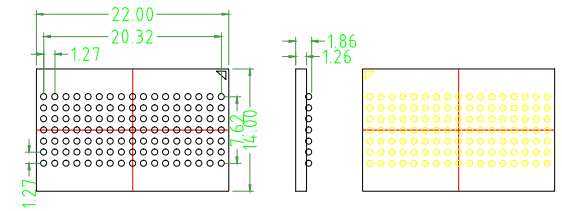
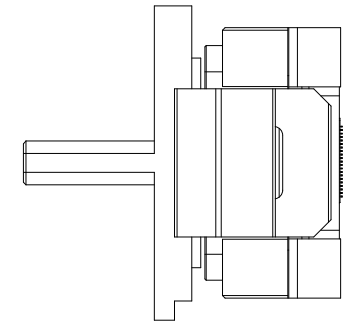
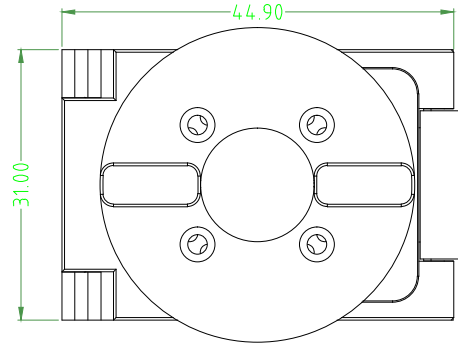
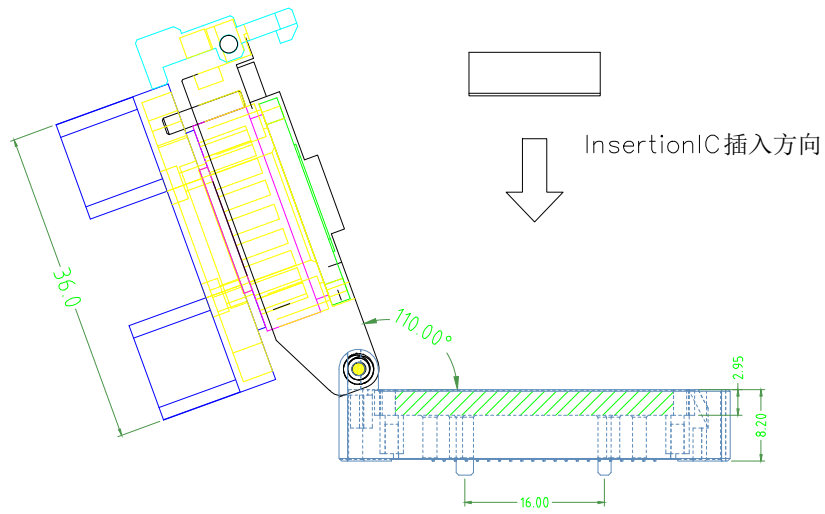


PCB PATTERN (Top View)



Chip



1、 MATERIAL AND FINISH

- 1、 SOCKET LID :PEI
- 2、 SOCKET BASE :PEI
- 3、 CONTACTS :BeCu,SELECTIVE Au-AuFLASH OVER NI PLATING
- 4、 SPRINGS :STAINLESS STEEL ,PASSIVATED

2、 PERFORMANCE

- 1、 Insulation Resistance : 1000MΩ or more at DC 100V
- 2、 Dielectric Withstanding Voltage: 100V AC for one minute
- 3、 Contact Resistance 80mΩ , MAX. at 10mA and 20mV MAX.(Initial)
- 4、 Operation Temperature -50°C~+150°C
- 5、 Life Span 10,000 Times (Mechanical)
- 6、 Operation Force 3.0 Kg MAX

△ C				DWG NO		PART NAME	ASS51-XGA119(B22X14)-1.27
△ B				MATERIAL	SCALE	1:1	TITLE
△ A				QTY	1	UNIT	mm
REV	DESCRIPTION	DATE	CHECK	SHEET	1 OF 1	REV	01
APPLICATION				APPROVE	DATE		
ANGLES	FINISH	ROUGH EDGE	ME TRIC	0.X:±0.1	CHECK	DATE	
ALL UNSPECIFIED CHAMFERS:0.2				DEGK	DATE	20181224	